# **Switching Transistor**

# **PNP Silicon**

## Features

- Moisture Sensitivity Level: 1
- ESD Rating: Human Body Model; 4 kV, Machine Model; 400 V
- Pb-Free Package is Available

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-40	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-40	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	-600	mAdc

#### **THERMAL CHARACTERISTICS**

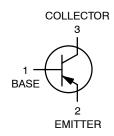
Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board T <sub>A</sub> = 25°C	P <sub>D</sub>	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\thetaJA}$	833	°C/W
Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

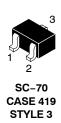
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.



# **ON Semiconductor®**

http://onsemi.com





## MARKING DIAGRAM



2T = Specific Device Code D = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMBT4403WT1	SC-70	3000/Tape & Reel
MMBT4403WT1G	SC–70 (Pb–Free)	3000/Tape & Reel

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic		Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (Note 1) ( $I_C = -1.0$ mAdc, $I_B = 0$ )	V <sub>(BR)CEO</sub>	-40	-	Vdc
Collector-Base Breakdown Voltage ( $I_C = -0.1 \text{ mAdc}, I_E = 0$ )	V <sub>(BR)CBO</sub>	-40	-	Vdc
Emitter-Base Breakdown Voltage ( $I_E = -0.1 \text{ mAdc}, I_C = 0$ )	V <sub>(BR)EBO</sub>	-5.0	-	Vdc
Base Cutoff Current (V <sub>CE</sub> = -35 Vdc, V <sub>EB</sub> = -0.4 Vdc)	I <sub>BEV</sub>	-	-0.1	μAdc
Collector Cutoff Current (V <sub>CE</sub> = $-35$ Vdc, V <sub>EB</sub> = $-0.4$ Vdc)	ICEX	-	-0.1	μAdc

# **ON CHARACTERISTICS**

$ \begin{array}{l} \mbox{DC Current Gain} \\ (I_C = -0.1 \mbox{ mAdc, } V_{CE} = -1.0 \mbox{ Vdc}) \\ (I_C = -1.0 \mbox{ mAdc, } V_{CE} = -1.0 \mbox{ Vdc}) \\ (I_C = -10 \mbox{ mAdc, } V_{CE} = -1.0 \mbox{ Vdc}) \\ (I_C = -150 \mbox{ mAdc, } V_{CE} = -2.0 \mbox{ Vdc}) \mbox{ (Note 1)} \\ (I_C = -500 \mbox{ mAdc, } V_{CE} = -2.0 \mbox{ Vdc}) \mbox{ (Note 1)} \end{array} $	h <sub>FE</sub>	30 60 100 100 20	- - 300 -	-
Collector – Emitter Saturation Voltage (Note 1) ( $I_C = -150 \text{ mAdc}, I_B = -15 \text{ mAdc}$ ) ( $I_C = -500 \text{ mAdc}, I_B = -50 \text{ mAdc}$ )	V <sub>CE(sat)</sub>	-	-0.4 -0.75	Vdc
Base – Emitter Saturation Voltage (Note 1) $(I_C = -150 \text{ mAdc}, I_B = -15 \text{ mAdc})$ $(I_C = -500 \text{ mAdc}, I_B = -50 \text{ mAdc})$	V <sub>BE(sat)</sub>	-0.75 -	-0.95 -1.3	Vdc

#### SMALL-SIGNAL CHARACTERISTICS

Current-Gain – Bandwidth Product ( $I_C = -20$ mAdc, $V_{CE} = -10$ Vdc, f = 100 MHz)		200	-	MHz
Collector-Base Capacitance ( $V_{CB} = -10$ Vdc, $I_E = 0$ , f = 1.0 MHz)	C <sub>cb</sub>	-	8.5	pF
Emitter-Base Capacitance ( $V_{BE}$ = -0.5 Vdc, $I_C$ = 0, f = 1.0 MHz)	C <sub>eb</sub>	-	30	pF
Input Impedance ( $I_C = -1.0$ mAdc, $V_{CE} = -10$ Vdc, f = 1.0 kHz)	h <sub>ie</sub>	1.5	15	kΩ
Voltage Feedback Ratio ( $I_C = -1.0$ mAdc, $V_{CE} = -10$ Vdc, f = 1.0 kHz)	h <sub>re</sub>	0.1	8.0	X 10 <sup>-4</sup>
Small-Signal Current Gain (I <sub>C</sub> = -1.0 mAdc, V <sub>CE</sub> = -10 Vdc, f = 1.0 kHz)	h <sub>fe</sub>	60	500	-
Output Admittance ( $I_C = -1.0 \text{ mAdc}$ , $V_{CE} = -10 \text{ Vdc}$ , f = 1.0 kHz)	h <sub>oe</sub>	1.0	100	μmhos

#### SWITCHING CHARACTERISTICS

Delay Time	(V <sub>CC</sub> = −30 Vdc, V <sub>EB</sub> = −2.0 Vdc,	t <sub>d</sub>	-	15	70
Rise Time	$I_{\rm C} = -150 \text{ mAdc}, I_{\rm B1} = -15 \text{ mAdc}$	t <sub>r</sub>	-	20	ns
Storage Time	(V <sub>CC</sub> = −30 Vdc, I <sub>C</sub> = −150 mAdc,	t <sub>s</sub>	-	225	70
Fall Time	$I_{B1} = I_{B2} = -15 \text{ mAdc}$ )	t <sub>f</sub>	-	30	ns

1. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

## SWITCHING TIME EQUIVALENT TEST CIRCUIT

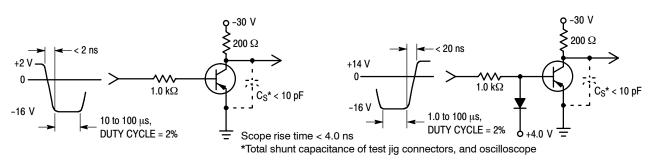
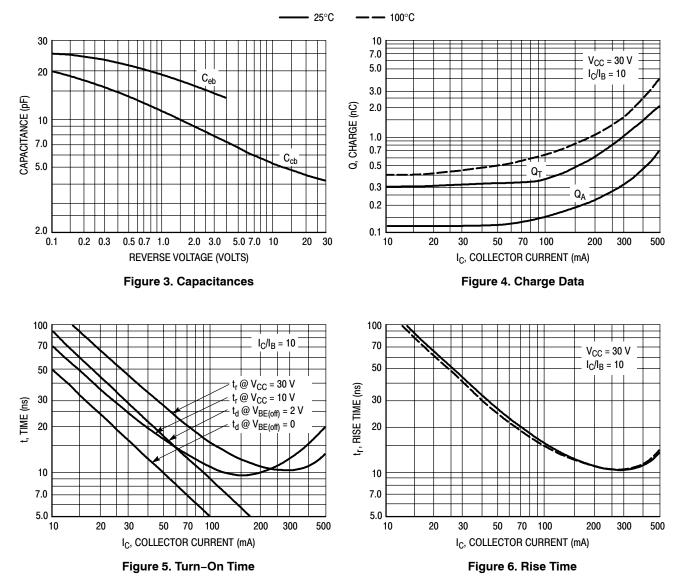


Figure 1. Turn-On Time

Figure 2. Turn-Off Time

## TRANSIENT CHARACTERISTICS



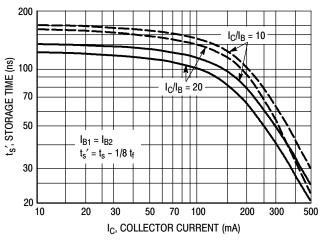
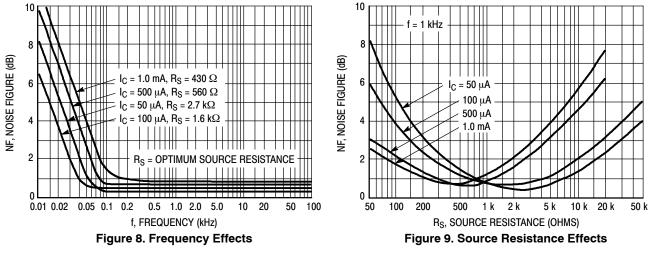


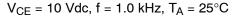
Figure 7. Storage Time

#### SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE

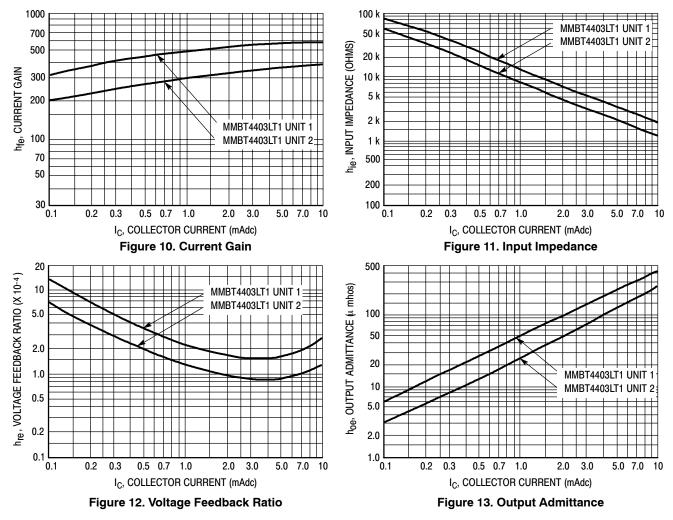
 $V_{CE} = -10$  Vdc,  $T_A = 25^{\circ}C$ ; Bandwidth = 1.0 Hz



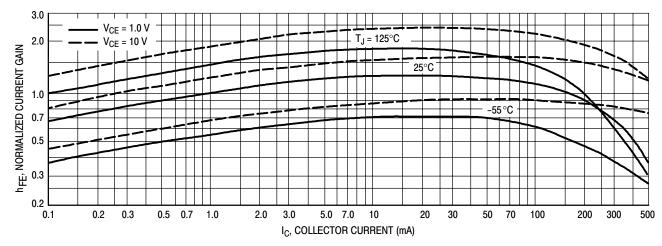
h PARAMETERS



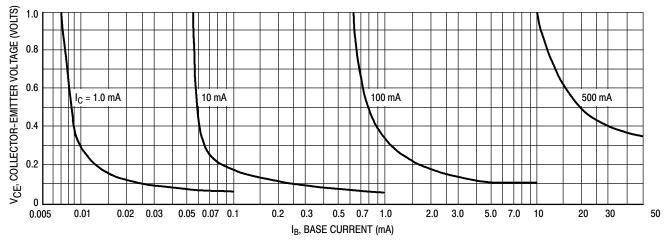
This group of graphs illustrates the relationship between  $h_{fe}$  and other "h" parameters for this series of transistors. To obtain these curves, a high–gain and a low–gain unit were selected from the MMBT4403LT1 lines, and the same units were used to develop the correspondingly numbered curves on each graph.

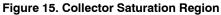












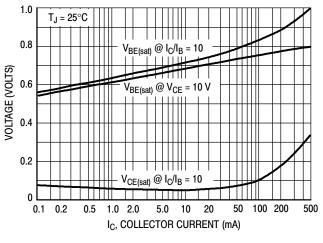
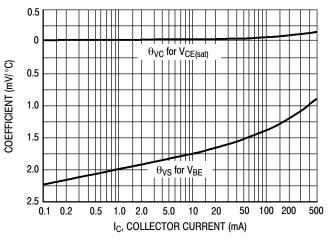


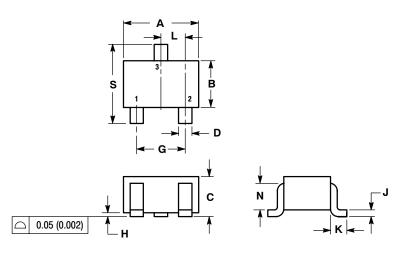
Figure 16. "On" Voltages





#### PACKAGE DIMENSIONS

SC-70/SOT-323 CASE 419-04 **ISSUE L** 



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI

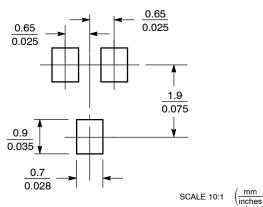
Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
С	0.032	0.040	0.80	1.00
D	0.012	0.016	0.30	0.40
G	0.047	0.055	1.20	1.40
Н	0.000	0.004	0.00	0.10
J	0.004	0.010	0.10	0.25
Κ	0.017 REF		0.425 REF	
L	0.026 BSC		0.650 BSC	
Ν	0.028	0.028 REF		) REF
S	0.079	0.095	2.00	2.40

STYLE 3: PIN 1. BASE 2. EMITTER

3. COLLECTOR

#### SOLDERING FOOTPRINT\*



#### SC-70/SOT-323

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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